



190115457 Cut Tape Packing Method Standardization for Modules with non-Reel Packing

Bulletin Issue Date: 1/15/2019

Effective Date: 1/15/2019

Description of Change

Silicon Labs is announcing standardization of the packing method for modules shipped in non-reel packing. The Cut Tape packing method will be used for modules in sealed carrier tape pockets without leader and trailer empty pockets.

Reason for Change

To standardize Cut Tape packing method for all Silicon Labs modules with non-reel part number.

Product Identification

Existing Part #

ABM1XX
ABM2XX
ABM3XX
AMS0XX
AMW0XX
AMW1XX
BGM1XX
BGM2XX
BLE1XX
BT1XX
ETRX357X
ETRX358X
MGM1XX
MGM2XX
WF11X
WF12X
WT11X
WT12X
WT32X
WT41X
ZM3XX
ZM5XX

Where 'XX' represents additional orderable part numbers that begin with the same prefix.

This change is considered a minor change which does not affect form, fit, function, quality, or reliability. The information is being provided as a customer courtesy.

Please contact your local Silicon Labs sales representative with any questions about this notification. A list of Silicon Labs sales representatives may be found at <http://www.silabs.com>.

Customer Actions Needed:

No action is needed from customers

User Registration

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Cut tape - Sample Photo



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